

# **FLO SERIES**

## PART NUMBER: **SA-EL-FLB**

## **Buffers**

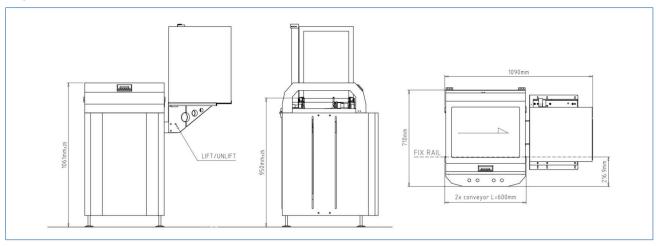
FIFO/LIFO buffer

This module uses a lifting platform to place PCB into the magazine. The capacity of the buffer depends on the total high of the circuit board, normally 50 positions at pitch 10mm.

FIFO/LIFO and pass through are selectable operation modes. Also used as G/B PCB separator.



### **Layout Module**



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### FLO SERIES GENERAL FEATURES

TRANSPORT	
Height:	950 mm +/- 25 mm
Width:	Min. 90 mm – Max 350 mm
PCB edge space:	Min. 3 mm
Transfer direction:	Left to right
Operating side:	Front of the machine
Fixed Rail:	Front of the machine
Interface:	Std. or Extd. SMEMA Opt Fuji, Panasonic, Sanyo, Siemens, SMPI, Special
SMEMA cable length:	3 m

PANEL DIMENSION	
Length:	Min. 90 mm – Max 450 mm
Width:	Min. 90 mm – Max 350 mm
Thickness:	From 0.8 mm to 4.0 mm
Component clearance:	Top: 40 mm Bottom: 20 mm
PCB max weight:	1 Kg
Max dimension of the rack:	L 460 x W 440 x H 570 (mm) External Measurements

#### **VARIOUS:**

CE safety compliant

• PLC microprocessor driven system

Mechanical keyboard or LCD display

• Single piece aluminium rails, proprietary design

**POWER SUPPLY:** 230V 1Ph+N+G 50Hz

2 Ampere **CURRENT:** 

AIR SUPPLY: 0.6 Mpa

**WEIGHT:** 90 Kg

1.100x750x1.500 mm (Rack Homing) **DIMENSION LXWXH:** 

**RAL 7035** COLOR:

TRASPARENT COVER: STANDARD (NO ESD)

All modules are ESD compliant and CE marked, each module has an independent control system. Technical specification may change without any advanced notice.



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